

**PLEDxN Series**



**Description**

The open LED protector provides a switching electronic shunt path when a single LED in an LED string fails as an open circuit. This ensures the entire LED string will continue to function even if a single LED in the string does not. This provides higher reliable lighting functions in applications such as headlights, aircraft lights, airport runway lighting, roadside warning lights, etc. This component is compatible with one watt rated LEDs with a nominal 350 mA current at 3V. The SOD-123FL package is one of the lowest height profiles (1.1 mm) packages offered in the industry.

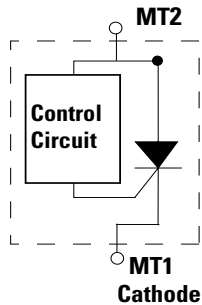
**Pinout Diagram**



**Features & Benefits**

- Fast switching
- Automatically resets after power cycle
- Compatible with industrial standard package SOD-123FL
- Compatible with industrial lighting environments
- IEC 61000-4-2 ESD 30kV (Air), 30kV (Contact)
- ESD protection of data lines in accordance with IEC 61000-4-2
- Low profile: maximum height of 1.1mm
- RoHS compliant and halogen-free
- MSL: Level 1 - unlimited

**Schematic Symbol**



**Electrical Characteristics (All parameters are measured at  $T_A = 25^\circ\text{C}$  unless otherwise noted)**

| Part Number | Marking | $V_{BR}$<br>@ $I_{BR} = 1 \text{ mAmps}$ |     | $I_{LEAK}$<br>$V_{MT2} = 5V$ | $I_H$       | $I_S$       | $I_T @ V_T$        | $V_T$<br>@ $I_T = 350\text{mA}$ | Critical rate of rise dV/dt | Capacitance<br>@ 1MHz, 2V bias |
|-------------|---------|--|-----|------------------------------|-------------|-------------|--------------------|---------------------------------|-----------------------------|--------------------------------|
|             |         | Volts                                    |     | $\mu\text{A}$                | $\text{mA}$ | $\text{mA}$ | $\text{A}$         | $\text{V}$                      |                             |                                |
|             |         | Min                                      | Max | Max                          | Max         | Max         | Max                | Max                             |                             |                                |
| PLED6N      | P6N     | 5.5                                      | 7.5 | 250                          | 12          | 70          | 1.0 <sup>1,2</sup> | 1.2                             | 250                         | 24                             |

**Notes:**  
**1)** Standard FR-4 PCB with Copper Pads (2mm x 2mm/pad)  
**2)** Aluminum PCB Pads (2mm x 3mm/pad)

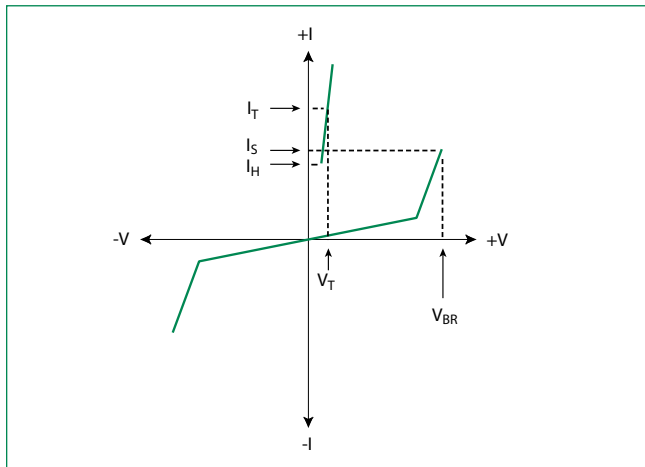
**Thermal Considerations**

| Symbol          | Parameter  | Value              | Unit               |
|-----------------|--|--------------------|--------------------|
| $I_T$           | Average On-State Current, ( $T_A = 25^\circ\text{C}$ ) | 1.0 <sup>1,2</sup> | A                  |
| $V_T$           | On-state Voltage ( $T_A = 125^\circ\text{C}$ )         | 1.0                | V                  |
| $P_D$           | Power Dissipation ( $T_A = 25^\circ\text{C}$ )         | 1.45 <sup>1</sup>  | W                  |
|                 |  | 1.50 <sup>2</sup>  |                    |
| $T_J$           | Operating Junction Temperature Range                   | -65 to +150        | $^\circ\text{C}$   |
| $T_S$           | Storage Temperature Range                              |                    | $^\circ\text{C}$   |
| $R_{\theta JL}$ | Thermal Resistance: Junction to Lead                   | 25 <sup>1</sup>    | $^\circ\text{C/W}$ |
|                 |  | 20 <sup>2</sup>    |                    |
| $R_{\theta JA}$ | Thermal Resistance: Junction to Ambient                | 80 <sup>1</sup>    | $^\circ\text{C/W}$ |
|                 |  | 50 <sup>2</sup>    |                    |

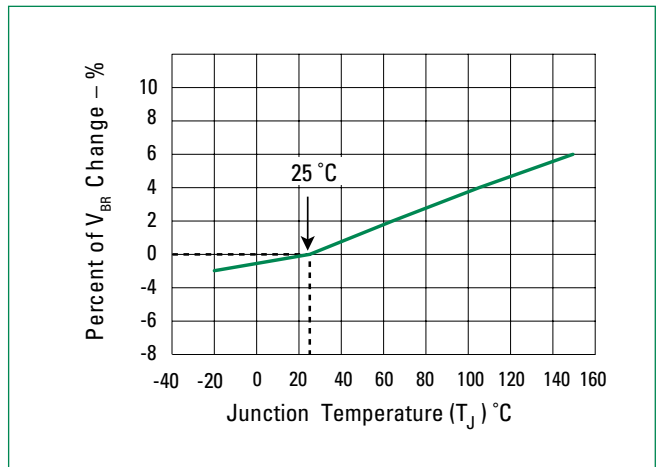
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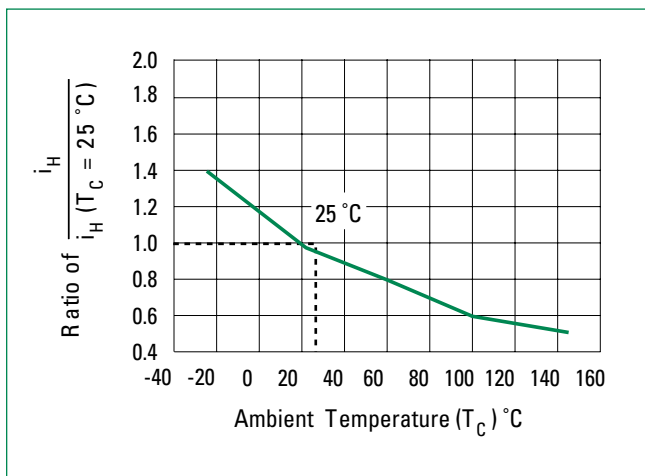
**V-I Characteristics**



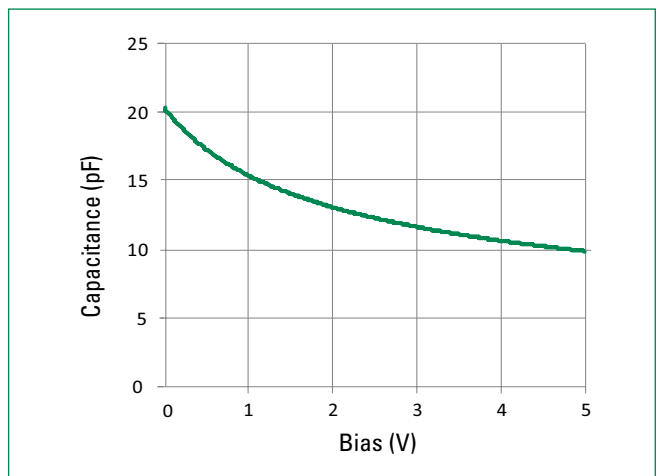
**$V_{BR}$  vs. Junction Temperature**



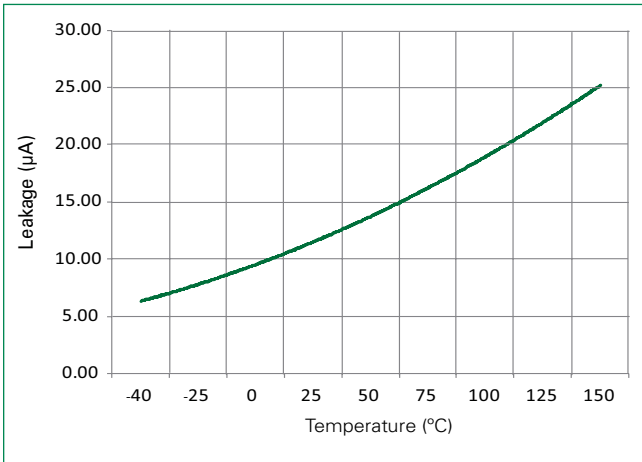
**Normalized DC Holding Current vs. Ambient Temperature**



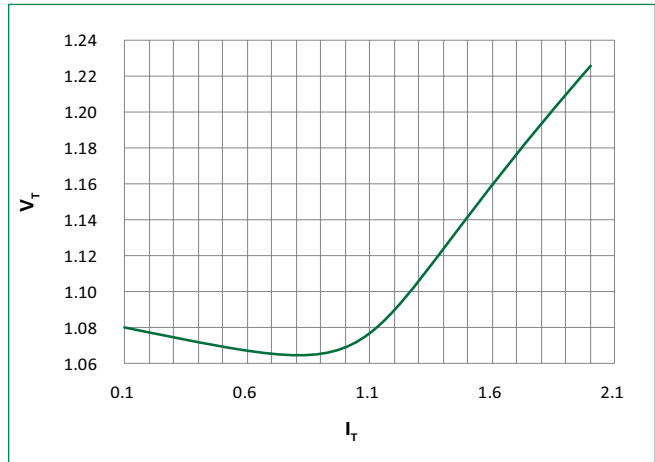
**Capacitance vs Voltage**



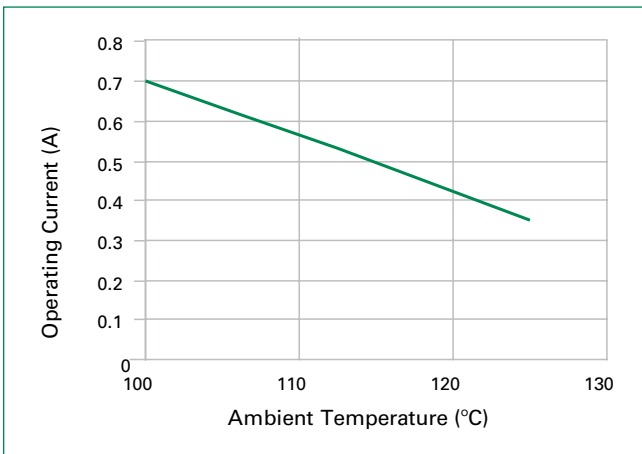
**Leakage Current vs Temperature**



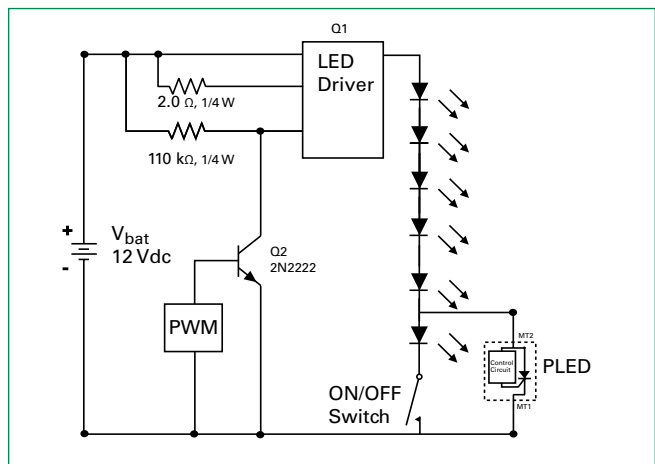
**$V_T$  vs  $I_T$**



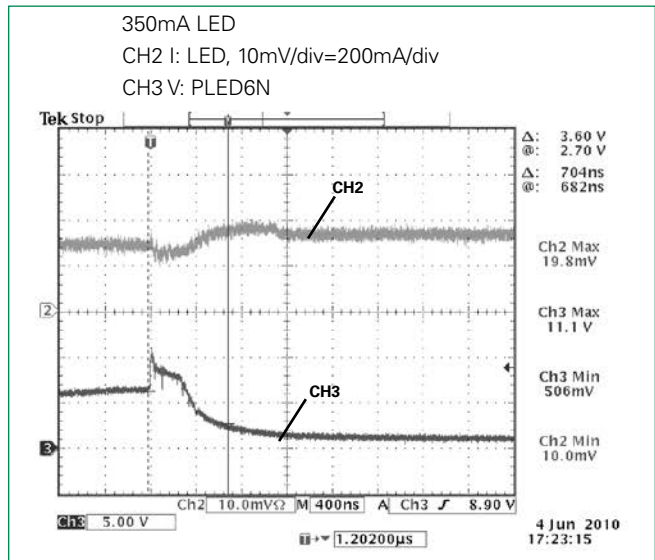
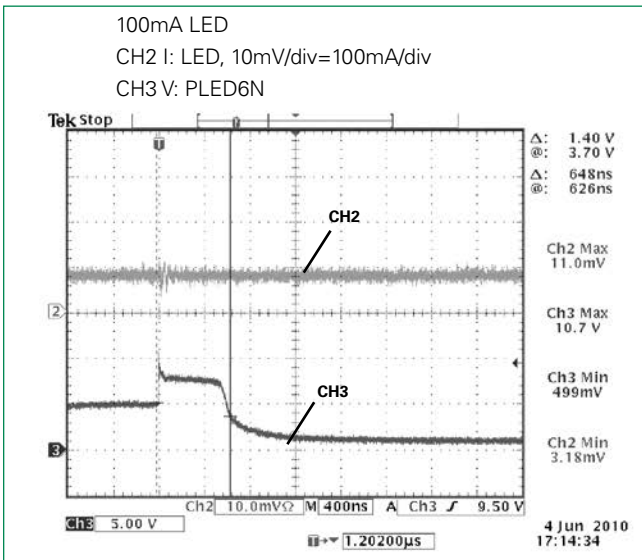
**Operating Current vs. Ambient Temperature**



**LED Interference Test Circuit**

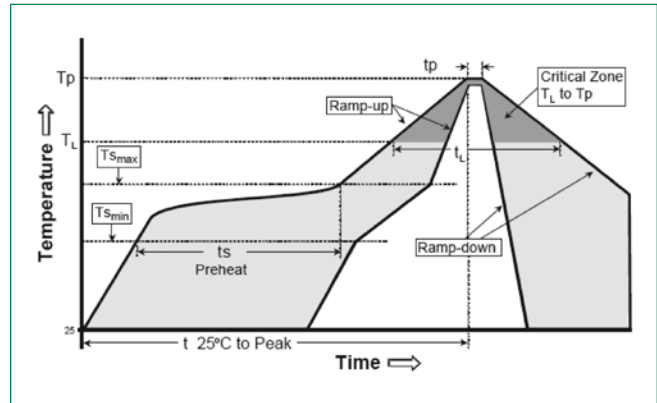


**Typical Operation Waveforms**



### Soldering Parameters

|  |                                    |                         |
|--|------------------------------------|-------------------------|
| <b>Reflow Condition</b>  |                                    | Pb – Free assembly      |
| <b>Pre Heat</b>  | - Temperature Min ( $T_{s(min)}$ ) | 150°C                   |
|  | - Temperature Max ( $T_{s(max)}$ ) | 200°C                   |
|  | - Time (min to max) ( $t_s$ )      | 60 – 180 secs           |
| <b>Average ramp up rate (Liquidus Temp (<math>T_L</math>) to peak)</b> |                                    | 3°C/second max          |
| <b><math>T_{s(max)}</math> to <math>T_L</math> - Ramp-up Rate</b>      |                                    | 3°C/second max          |
| <b>Reflow</b>  | - Temperature ( $T_L$ ) (Liquidus) | 217°C                   |
|  | - Temperature ( $t_L$ )            | 60 – 150 seconds        |
| <b>Peak Temperature (<math>T_p</math>)</b>                             |                                    | 260 <sup>+0/-5</sup> °C |
| <b>Time within 5°C of actual peak Temperature (<math>t_p</math>)</b>   |                                    | 30 seconds              |
| <b>Ramp-down Rate</b>  |                                    | 6°C/second max          |
| <b>Time 25°C to peak Temperature (<math>T_p</math>)</b>                |                                    | 8 minutes max           |
| <b>Do not exceed</b>   |                                    | 260°C                   |



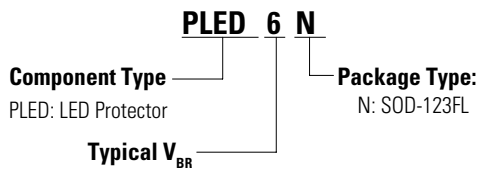
### Physical Specifications

|                          |   |
|--------------------------|---|
| <b>Terminal Material</b> | Copper Alloy  |
| <b>Terminal Finish</b>   | 100% Matte Tin Plated                                       |
| <b>Body Material</b>     | UL recognized epoxy meeting flammability classification V-0 |

### Packaging

| Package Code | Description | Packaging Quantity | Industry Standard        |
|--------------|-------------|--------------------|--------------------------|
| N            | SOD-123FL   | 3000               | EIA-481<br>Tape and Reel |

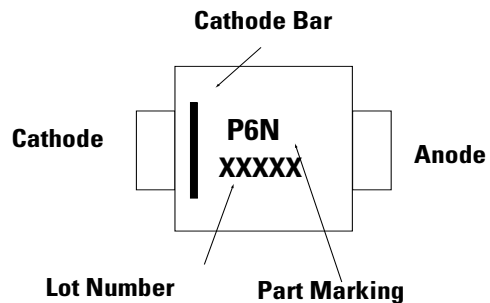
### Part Numbering System



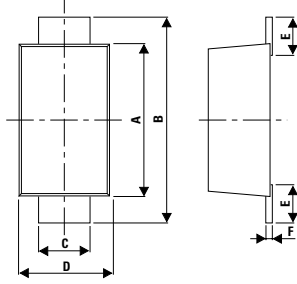
### Environmental Specifications

|  |  |
|--|--|
| <b>High Temperature Voltage Blocking</b> | MIL-STD-750: Method 1040, Condition A, 80% min $V_{BR}$ DC, 150°C, 504 hours |
| <b>Temperature Cycling</b>               | MIL-STD-750: Method 1051, -65°C to 150°C, 15-minute dwell, 100 cycles        |
| <b>Biased Temperature &amp; Humidity</b> | EIA/JEDEC: JESD22-A101, 80% min $V_{BR}$ , 85°C, 85%RH, 1008 hours           |
| <b>Resistance to Solder Heat</b>         | MIL-STD-750: Method 2031, 260°C, 10 seconds                                  |
| <b>Moisture Sensitivity Level</b>        | JEDEC-J-STD-020, Level 1   |
| <b>Burn-In Test</b>                      | $I_T = 0.350$ Adc, 1008 hours  |

### Part Marking System

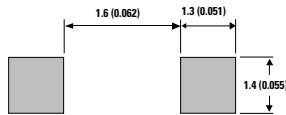


**Dimensions - SOD-123FL Package**

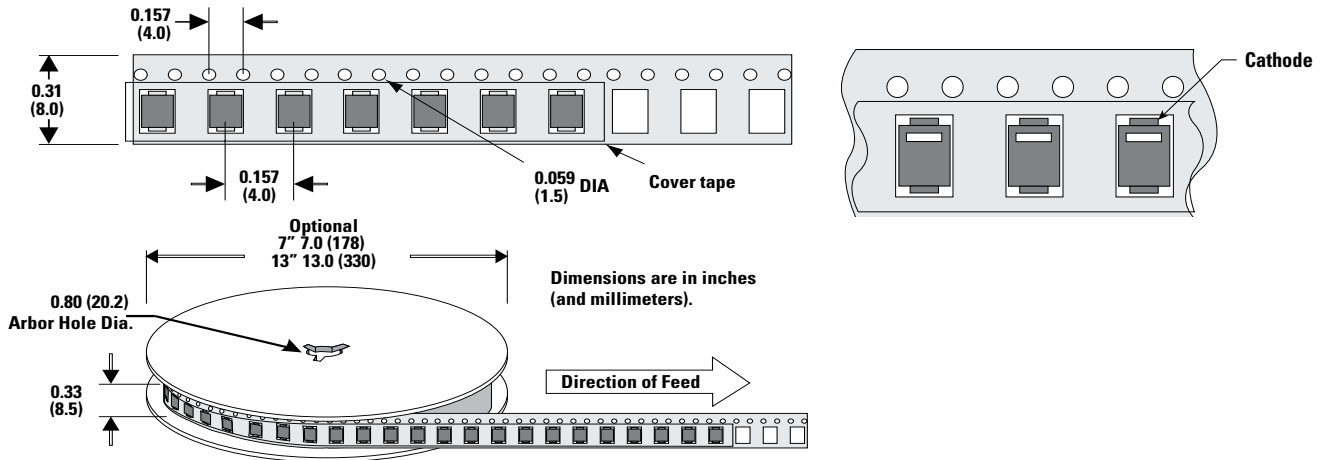


| Dimensions | Millimeters |      | Inches |        |
|------------|-------------|------|--------|--------|
|            | Min         | Max  | Min    | Max    |
| A          | 2.50        | 2.90 | 0.0984 | 0.1142 |
| B          | 3.40        | 3.90 | 0.1339 | 0.1535 |
| C          | 0.70        | 1.20 | 0.0275 | 0.0472 |
| D          | 1.50        | 2.00 | 0.0591 | 0.0787 |
| E          | 0.35        | 0.90 | 0.0138 | 0.0354 |
| F          | 0.05        | 0.26 | 0.0020 | 0.0102 |
| G          | 0.00        | 0.10 | 0.0000 | 0.0039 |
| H          | 0.95        | 1.10 | 0.0374 | 0.0433 |

**Mounting Pad Layout**



**Tape and Reel Specification**





Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



#### Как с нами связаться

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